

Contactless debarring is effective for processing lead frame which is easily deformed.

## **Features**

This system removes barriers of mold plastic packages by laser beam.

- Contactless debarring is effective for processing lead frame which is easily deformed.
- Laser does not need water or grinding materials for processing, so it is able to reduce a space and a running cost.
- Laser oscillator can be selected for your application.
- Highly precise debarring due to image processing.

## **Specifications**

Dimensions	Approx. 1200W x 1800D x 1600H mm
Laser	Fundamental laser for thick, SHG laser for thin
Dust collector	Air volume: 3.5?/min. Static pressure: 1.76kPa



